



N0W13S26

♦Outline(L*W*H): 3.5*2.8*1.9mm

◆Good thermal dissipation & optical uniformity

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Features

- Forward current: ≤30mA
- Typical viewing angle 50% Iv: 120°
- RoHS and REACH-compliant
- Lens color: yellowish
- Qualified according to JEDEC moisturevity
 Level 3
- ESD level ≥1kV(HBM)

Applications

- Indoor signage display applications
- Indoor decorating and entertainment design
- Flat backlight for LCD. Switch and symbol
- Indicator and backlighting for all consumer electronics

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1	2	3	4	5
Process Type	Category	LED Type Lead Brame		Dice Wavelength &Luminous Rank
1: normal product	S: SMD LED	C: PLCC top view	3528:	Wxxx: White
1. normai product	S. S. III EED	D: PLCC side view	3.5*2.8mm	William William

6	7	8	9
Lap Polarity	Lens Color	Bracket or COB Specifications	Assembly Code
0: non-common anode and	W: yellowish	E: article mode	CX: no expression above
non-common cathode	w. yenowish	E. article mode	meaning for company

■ Maximum Rating(Ta=25°C)

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Characteristics	Symbol	Typical	Unit
DC forward current	I_{F}	30	mA
Pulse forward current*3	${ m I}_{ m PF}$	100	mA
Reverse voltage	V_R	5	V
Junction temperature	T_{J}	110	°C
Operating temperature range	T_{OP}	-40-80	°C
Storage temperature range	T_{STG}	-40-100	°C
Soldering temperature*4	T_{SD}	260	°C

Note 1: There is no maximum or typical voltage parameter

- 2: For other ambient, limited setting of current will be depended on de-rating curves.
- 3: Duty 1/10, pulse width 0.1ms
- 4: The maximum of soldering time is 5 seconds in T_{SD}

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OPTOELECTRONIC CO.,LTD■ Typical Product Characteristics (Ta=25°C)

Characteristics	Symbol	Min.	Тур.	Max.	Unit	Test condition
Forward Voltage	V_{F}	2.8	3.2	3.6	V	I _F =20mA
Reverse Current	I_R	-	-	10	μΑ	$V_R = 5V$
Luminous Intensity	I_{V}	2050	2300	-	mcd	I _F =20mA
Viewing Angle	$2\theta_{1/2}$	-	120	-	deg	I _F =20mA
Colon Coordinate	X	-	0.363	-	-	I 20m A
Color Coordinate	У	-	0.366	-	-	$I_{F}=20\text{mA}$

Notes: 1. Measurement Errors:

Forward Voltage: ± 0.1 V, Luminous Intensity $\pm 10\%$, Viewing Angle: $\pm 5\%$, Color Coordinate $(x, y) \pm 0.006$,

Color Rendering Index: ±5

2. Electrical-Optical characteristics (Ta=25 $^{\circ}\text{C}$)

■ Range of Bins

1). Forward Voltage Bins (I_F=20mA)

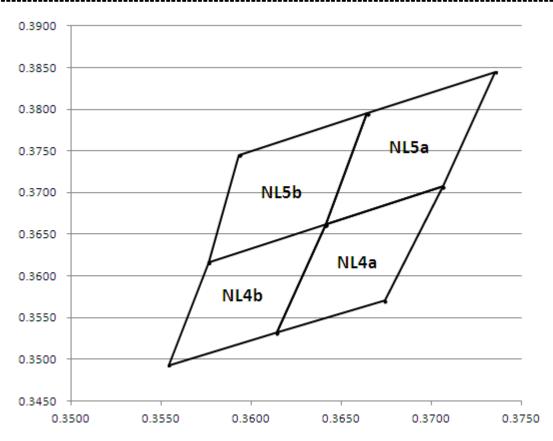
Bin Code	Min. V _F (V)	Min. V _F (V)
В	2.8	2.9
С	2.9	3.0
D	3.0	3.1
Е	3.1	3.2
F	3.2	3.3
G	3.3	3.4
Н	3.4	3.5
I	3.5	3.6

2). Luminous Intensity Bins (I_F=20mA)

Bin Code	Min. I _V	Max. I _V
Bill Code	(mcd)	(mcd)
6	2050	2250
7	2250	2450
8	2450	2650
9	2650	2850

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Color Rank

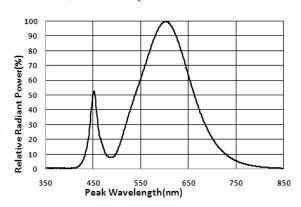
BIN 碼	X	Y	X	Y	X	Y	X	Y
NL4a	0.3641	0.3662	0.3614	0.3532	0.3674	0.3571	0.3706	0.3707
NL5a	0.3664	0.3795	0.3641	0.3662	0.3706	0.3707	0.3735	0.3845
NL4b	0.3576	0.3616	0.3554	0.3493	0.3614	0.3532	0.3641	0.36615
NL5b	0.3593	0.3745	0.3576	0.3616	0.3641	0.36615	0.3664	0.3795

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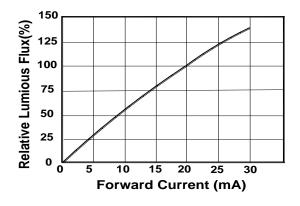


1

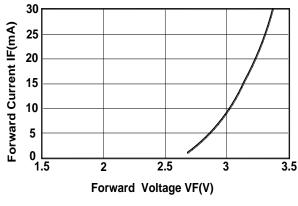
1). Relative Spectral Distribution



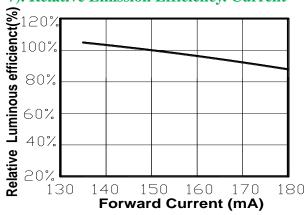
3). Relative Luminous Flux .Current



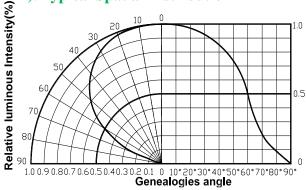
5). Electrical Characteristics



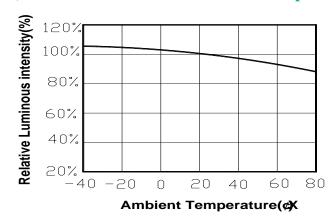
7). Relative Emission Efficiency. Current



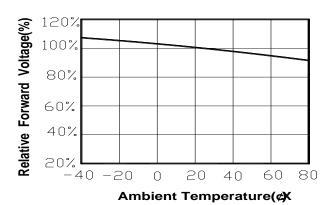
2). Typical Spatial Distribution



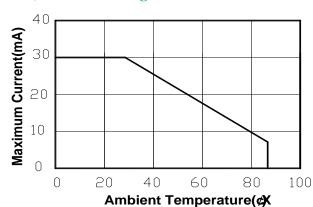
4). Relative Luminous Flux . Ambient Temperature



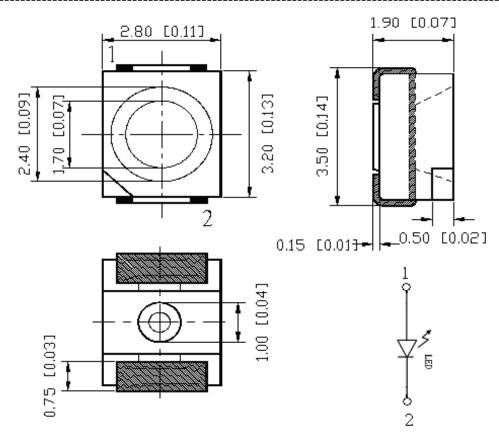
6). Forward Voltage Temperature



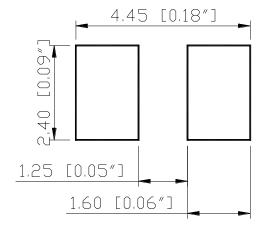
8). Thermal Design







RECOMMEND PADLAYOUT



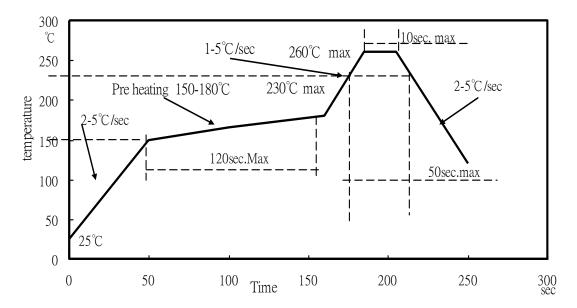
Notes: 1. All dimensions are in millimeters (inches)

- 2. Tolerance is ± 0.1 (0.004) mm unless otherwise noted
- 3. Specifications are subject to change without notice.

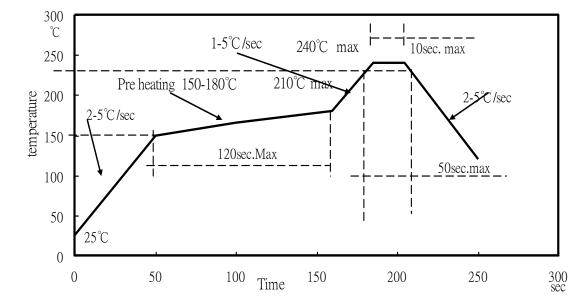
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1. I_R reflow soldering Profile for Lead Free solder



2. I_R reflow soldering Profile for Lead solder



Notes:

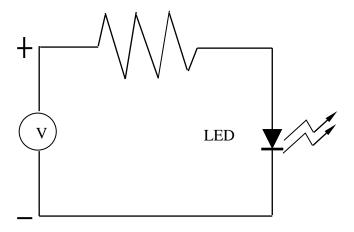
- 1. We recommend the reflow temperature 240°C ($\pm 5^{\circ}\text{C}$).the maximum soldering temperature should be limited to 260°C .
- 2. Don't cause stress to the silicone resin while it is exposed to high temperature.
- 3. Number of reflow process shall be less than 3 times.

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■ Test Circuit and Handling Precautions

1. Test circuit



2. Handling precautions

2.1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

2.2. Storage

1). It is recommended to store the products in the following conditions:

Humidity: 60% R.H. Max.

Temperature : $5^{\circ}\text{C} \sim 30^{\circ}\text{C} (41^{\circ}\text{F} \sim 86^{\circ}\text{F})$

2). Shelf life in sealed bag: 12 month at $<5^{\circ}\text{C} \sim 30^{\circ}\text{C}$ and <60% R.H. after the package is Opened, the products should be used within a week or they should be keeping to stored at $\leq 20\%$ R.H. with zip-lock sealed.

2.3. Baking

It is recommended to baking before soldering when the pack is unsealed after 24hrs.

The Conditions are as followings:

1). $60\pm3^{\circ}$ C X 6hrs and <5%RH, for reel

2). 125±3°C X 2hrs, for single LED

It shall be normal to see slight color fading of carrier (light yellow) after baking in process

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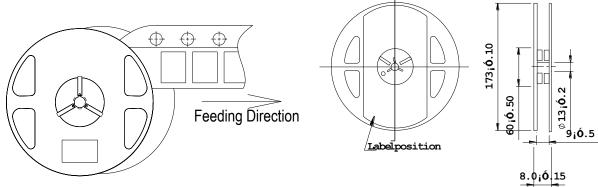
Unit:mm

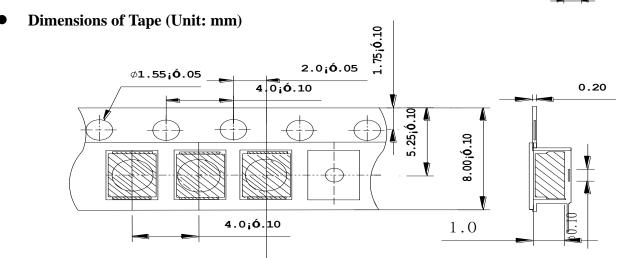


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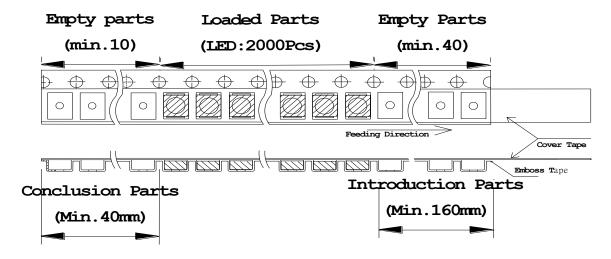
Feeding Direction

Dimensions of Reel (Unit: mm)





Arrangement of Tape



Notes:

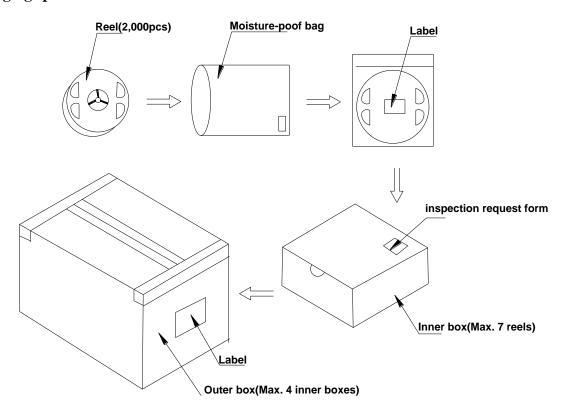
- 1. Empty component pockets are sealed with top cover tape
- 2. The max loss number of SMD is 2pcs
- 3. The cathode is oriented towards the tape sprocket hole in accordance with ANSI/EIA RS-481 specifications
- 4. 2,000pcs per reel

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Packing

Packaging specifications



Notes:

Reeled product (max.2,000) is packed in a sealed moisture-proof bag. Seven bags are packed in an inner box (size: about 260 X 230 X 100 mm) and four inner boxes are in an outer box (size: about 480 X 275 X 215 mm). On the label of moisture-poof bag, there should be the information of Part No., Lot No. and quantity number; also the total quantity number should be on inspection request form on outer box.

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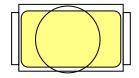
1. Abnormal situation caused by improper setting of collet

To choose the right collet is the key issue in improving the product's quality. LED is different from other electronic components, which is not only about electrical output but also for optical output. This characteristic made LED more fragile in the process of SMT. If the collet's lowering down height is not well set, it will bring damage to the gold wire at the time of collet's picking up and loading which will cause the LED fail to light up, light up now and then or other quality problems

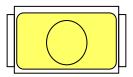
2. How to choose the collet

During SMT, please choose the collet that has larger outer diameter than the lighting area of lens, in case that improper position of collet will damage the gold wire inside the LED. Different collets fit for different products, please refer to the following pictures cross out

Outer diameter of collet should be larger than the lighting area







Picture 2(X)

3. Other points for attention

- A. No pressure should be exerted to the epoxy shell of the SMD under high temperature.
- B. Do not scratch or wipe the lens since the lens and gold wire inside are rather fragile and cross out easy to break.
- C. LED should be used as soon as possible when being taken out of the original package, and should be stored in anti-moisture and anti-ESD package.

4. This usage and handling instruction is only for your reference.

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OPTOELECTRONIC CO.,LTD Test Items and Results of Reliability

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Test Item	Test Conditions	Duration/ Cycle	Ac/Re	Number of Damage	Reference
Normal Temperature Life	$Ta=23^{\circ}C(\pm 5^{\circ}C)$ $I_F=20mA$	1008 hrs	0/1	0/22	JESD22 A-108
High Temperature Life	$Ta=85^{\circ}C(\pm 5^{\circ}C)$ $I_F=20mA$	1008 hrs	0/1	0/22	JESD22 A-108
High Humidity Heat Life	$Ta = 85^{\circ}C(\pm 5^{\circ}C)$ RH = 85% $I_F = 20mA$	1008 hrs	0/1	0/22	JESD22 A-108
Thermal shock	-45°C/30min~105°C /30min (±5°C)	1008 hrs	0/1	0/22	JESD22 A-104
Electrostatic Discharge (ESD) Test	According to the SPEC	3 cycles	0/1	0/22	AEC Q101-001
Low Temperature Storage	T _a =-40°C	1008 hrs	0/1	0/22	JESD22-A103D
High Temperature Storage	T _a =125℃	1008 hrs	0/1	0/22	JESD22-A103D

*Criteria for Judging						
140	Camab al	Candition	Criteria for Judgment of Pass			
Item	Symbol	Condition	Min	Max		
Forward Voltage	V_{F}	I _F =20mA	-	$USL^{*1} \times 1.1$		
Reverse Current	I_R	$V_R = 5V$	-	10μΑ		
Luminous Intensity	Iv	I _F =20mA	LSL*2×0.7	-		

[Note] USL*1: Upper Specification Level

LSL*2: Lower Specification Level

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